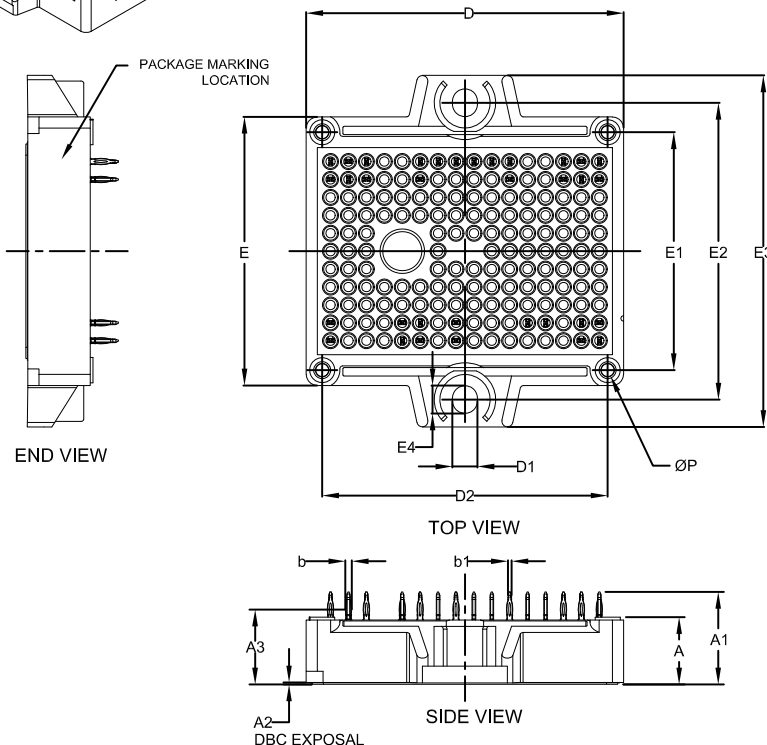


PIM34 56.70x42.50x12.00  
CASE 180HU  
ISSUE A

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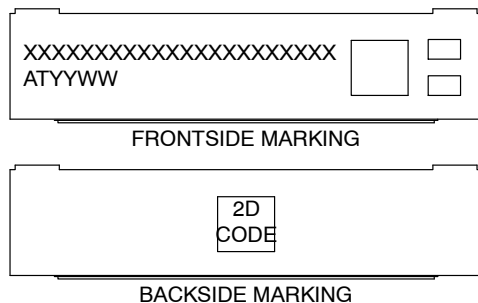


NOTES:

1. CONTROLLING DIMENSION: MILLIMETERS
2. PIN POSITION TOLERANCE IS  $\pm 0.4\text{mm}$
3. PRESS FIT PIN

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	11.65	12.00	12.35
A1	16.10	16.50	16.90
A2	0.00	0.35	0.60
A3	12.85	13.35	13.85
b	1.15	1.20	1.25
b1	0.59	0.64	0.69
D	56.40	56.70	57.00
D1	4.40	4.50	4.60
D2	50.85	51.00	51.15
E	47.70	48.00	48.30
E1	42.35	42.50	42.65
E2	52.90	53.00	53.10
E3	62.30	62.80	63.30
E4	4.90	5.00	5.10
P	2.20	2.30	2.40

GENERIC  
MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
AT = Assembly & Test Site Code  
YYWW = Year and Work Week Code

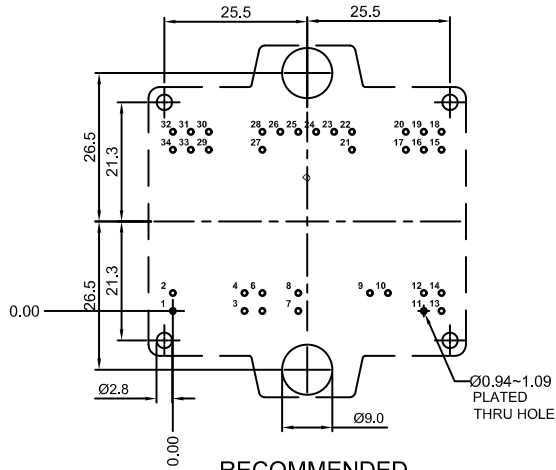
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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**RECOMMENDED  
MOUNTING PATTERN**

\* For additional Information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Note2:

Pin	X	Y	Pin	X	Y
1	0	0	18	48	32
2	0	3.2	19	44.8	32
3	12.8	0	20	41.6	32
4	12.8	3.2	21	32	28.8
5	16	0	22	32	32
6	16	3.2	23	28.8	32
7	22.4	0	24	25.6	32
8	22.4	3.2	25	22.4	32
9	35.2	3.2	26	19.2	32
10	38.4	3.2	27	16	28.8
11	44.8	0	28	16	32
12	44.8	3.2	29	6.4	28.8
13	48	0	30	6.4	32
14	48	3.2	31	3.2	32
15	48	28.8	32	0	32
16	44.8	28.8	33	3.2	28.8
17	41.6	28.8	34	0	28.8

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